## "Yـ / Descriptions

TO-220FL N 650V

N-CHANNEL 650V Super-Junction Power MOSFET in a TO-220FL Plastic Package.

## ◕ È / Features

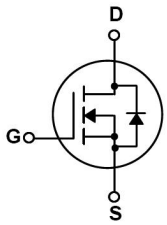
$R_{DS(on)}$×Qg 100% ROHS

Very low $R_{DS(on)}$×Qg,100%avalanche tested,RoHS compliant,HF Product.

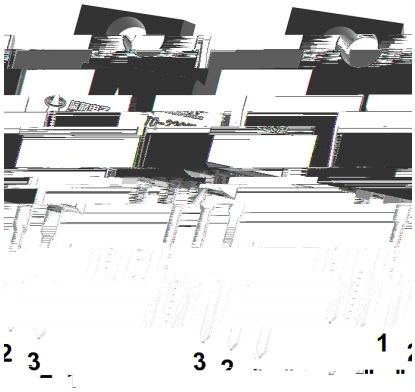
## ४ ڍ / Applications

For switch mode power supply, uninterruptible power supply, power factor correction.

## Л ف ۊ ≠ ع / Equivalent Circuit




## ã ﻝ ù / Pinning




PIN1 G PIN 2 D PIN 3 S

## ł. ʜ ڬ / Marking

See Marking Instructions.

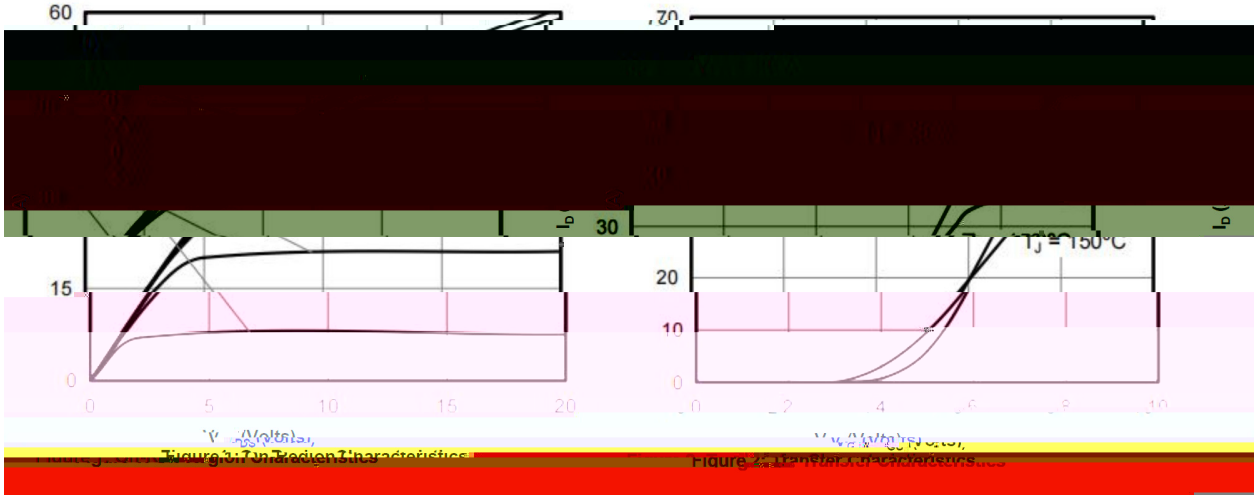
| Parameter | Symbol | Rating | Unit |
|---|---|---|---|
| Drain-Source Voltage | $V_{DSS}$ | 650 | V |
| Drain Current | $I_D$(Tc=25 ) | 20 | A |
| Drain Current - Pulsed | $I_{DM}$ | 60 | A |
| Gate-Source Voltage | $V_{GS}$ | ±30 | V |
| Single Pulsed Avalanche Energy | $E_{AS}$ | 488 | mJ |
| Avalanche Current | $I_{AS}$ | 9.5 | A |
| Power Dissipation | $P_D$(Tc=25 ) | 34 | W |
| Operating and Storage Temperature Range | $T_J$,T91uc | -55 to 1V0 | |
| Junction-to-Case | $R_{dJC}$ | 3.6 | /W |
| Junction-to-Ambient | $R_{dJA}$ | 80 | /W |

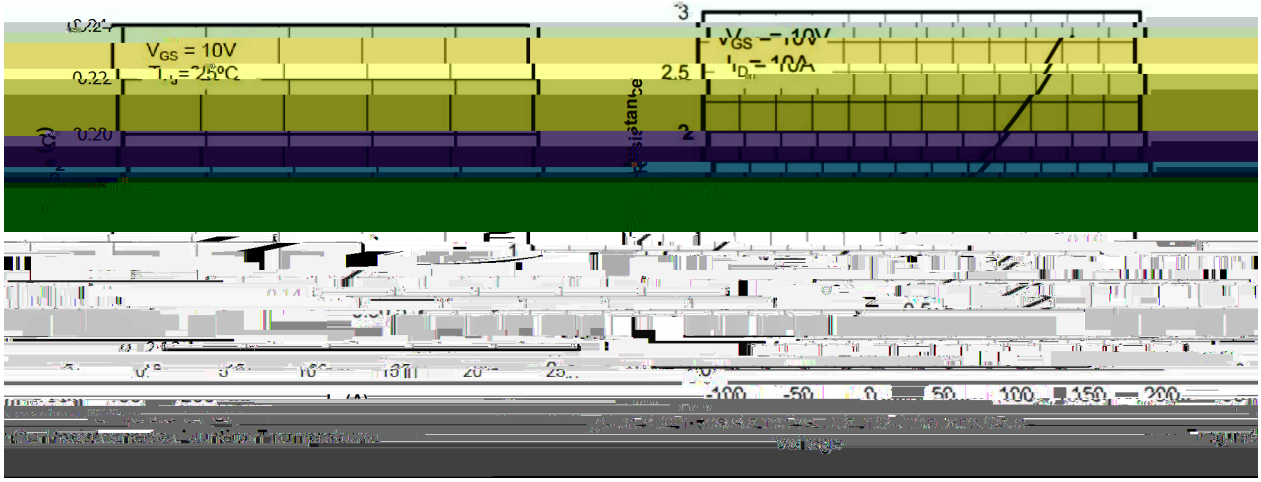
| Parameter | Symbol | Test Conditions | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|
| Drain-Source Breakdown Voltage | $BV_{DSS}$ | $V_{GS}$=0V $I_D$=250εA | 650 | | | V |
| Zero Gate Voltage Drain Current | $I_{DSS}$ | $V_{DS}$=650V $V_{G$}$=0V $T_J$=25 | | | 1.0 | εA |
| Gate-Body Leakage Current, Forward | $I_{GSS}$ | $V_{GS}$=±30V | | | ±100 | nA |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS}$=$V_{GS}$ $I_D$=250εA | 2.5 | | 4.5 | V |
| Static Drain-Source On-Resistance | $R_{DS(on)}$ | $V_{GS}$=10V $I_D$=10A | | 150 | 180 | mq |
| Drain-Source Diode Forward Voltage | $V_{SD}$ | $V_{GS}$=0V $I_{sd}$=1A $T_J$=25 | | | 1.2 | V |
| Gate Resistance | $R_g$ | $V_{GS}$ = 0V f = 1.0MHz | | 3.5 | | q |
| Input Capacitance | $C_{iss}$ | | | 1500 | | pF |
| Output Capacitance | $C_{oss}$ | $V_{DS}$=100V $V_{GS}$=0V f=1.0MHz | | 3.1 00=0V ( )-457.4(pF ) | | |

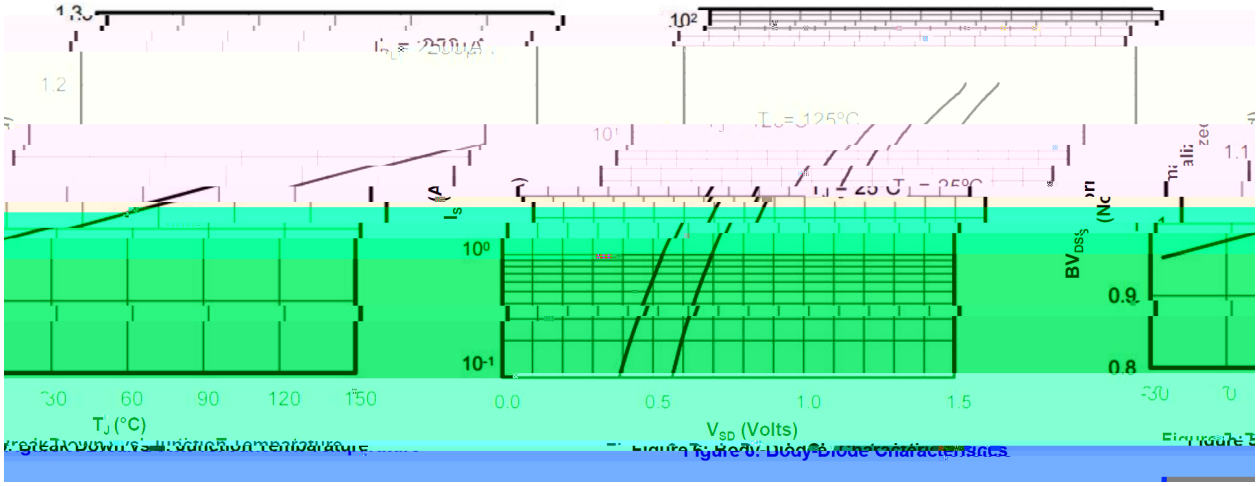
is 0 56 0 3380.98 85.38 .48.04 ref 056 12 342.

| Parameter | Symbol | Test Conditions | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|
| Continuous Diode Forward Current | $I_S$ | | | 20 | | A |
| Total Gate Charge | $Q_g$ | $V_{DS}$=480V $I_D$=10A $V_{GS}$=10V | | 28.1 | | nC |
| Gate-Source Charge | $Q_{gs}$ | | | 8.1 | | nC |
| Gate-Drain Charge | $Q_{gd}$ | | | 2.1 | | nC |
| Reverse recovery time | $t_{rr}$ | $V_R$=400 V, $I_F$=10A, $dI_F/dt$=100 A/εs | | 283 | | ns |
| Reverse recovery charge | $Q_{rr}$ | | | 3.3 | | uC |

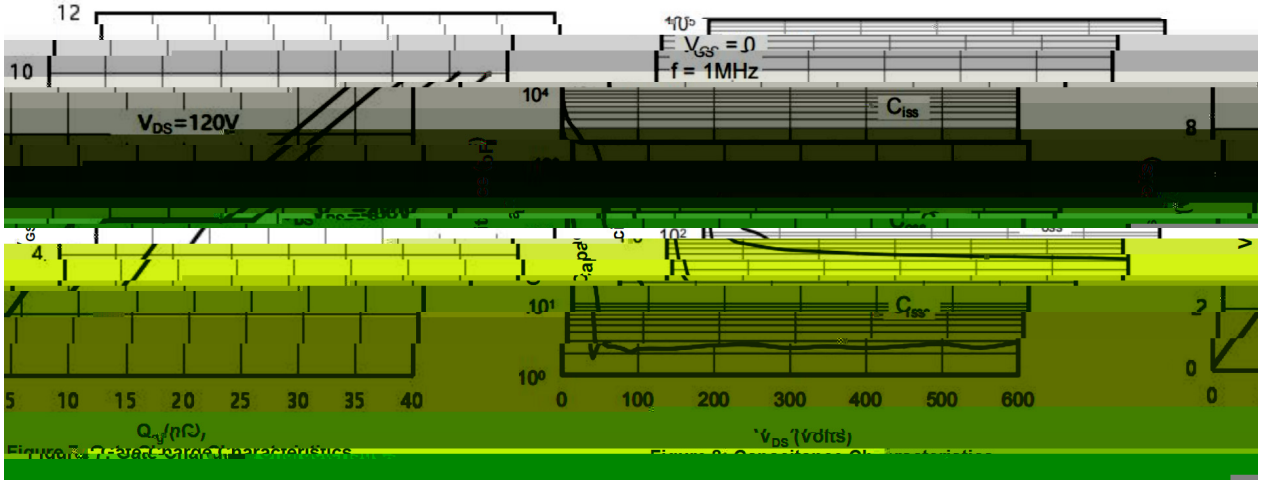
## ≠ Ǝ ÃΈ ℵ ƒ / Electrical Characteristic Curve

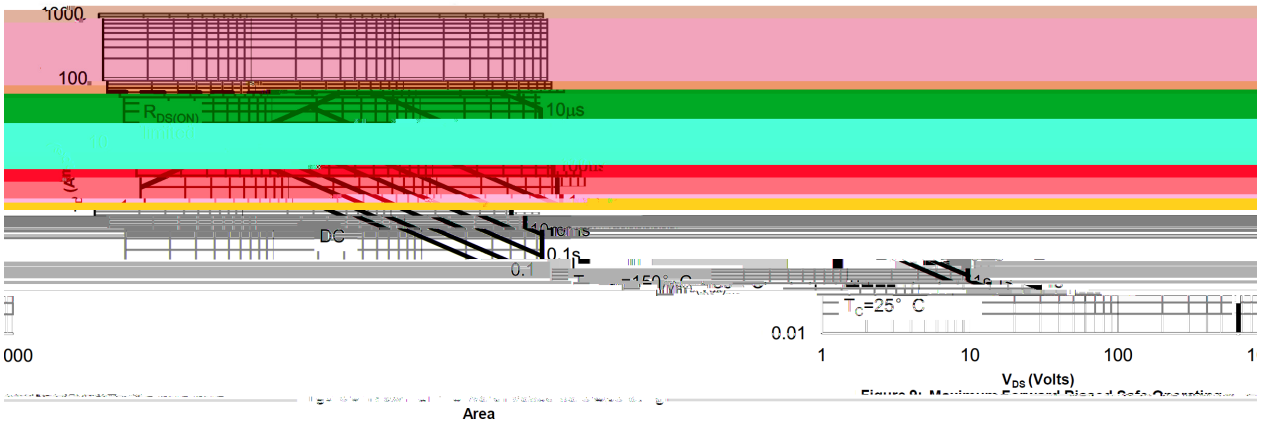


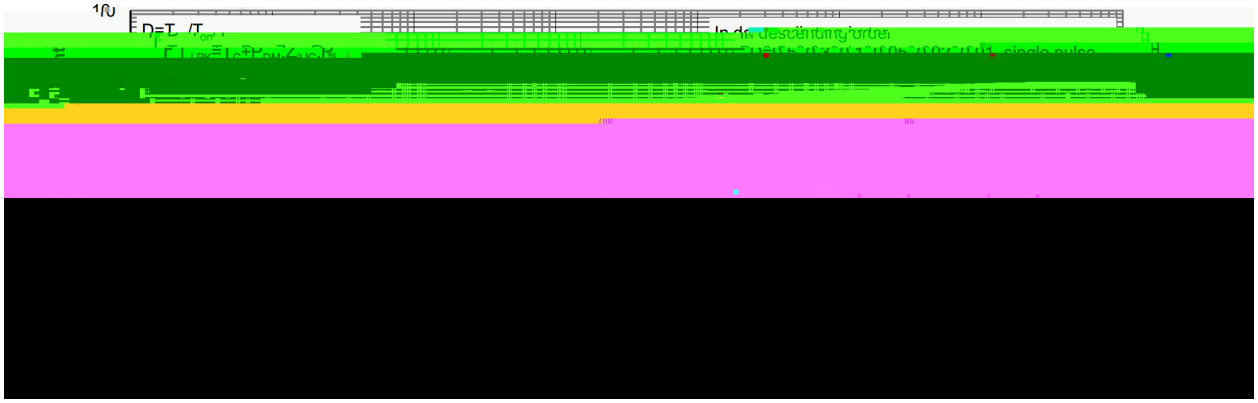



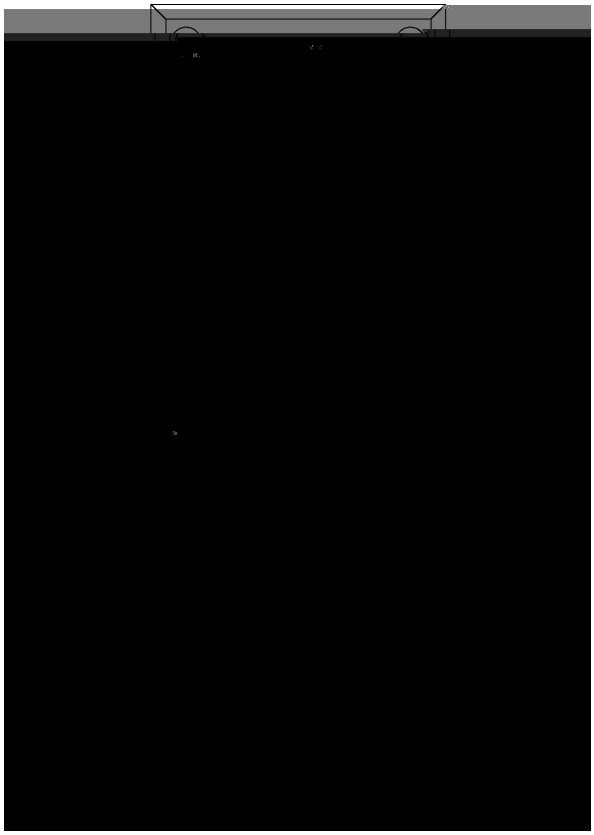
## ≠ Ǝ ÃʹE ∀ ƒ / Electrical Characteristic Curve



## ł. Ł‘Ω / Marking Instructions



BR

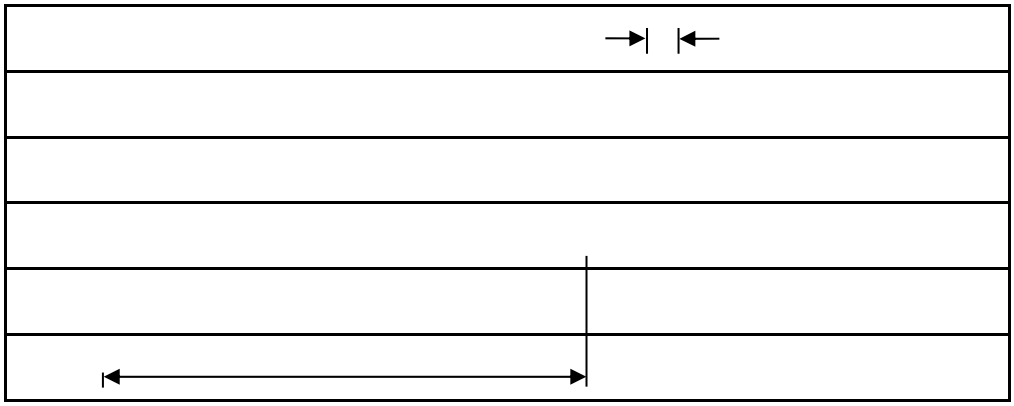
65R180T

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Note:

| | |
|---|---|
| BR: | Company Code |
| 65R180T: | Product Type Code |
| ****: | Lot No. Code, code change with Lot No |

## ↓ ș ╕ẅ´E ᛋ ƒ (ᾠ ᴈ) / Temperature Profile for Dip Soldering(Pb-Free)



Note:

| | | | | |
|---|---|---|---|---|
| 1 | 25 | 150 | 60 | 90sec; |
| 2 | 255±5 | | | 5±0.5sec; |
| 3 | | 2 | 10 | /sec. |

1.Preheating:25~150 , Time:60~90sec.
2.Peak Temp.:255±5 , Duration:5±0.5sec.
3. Cooling Speed: 2~10 /sec.

## ᐟ ŭ ɋ ̄ ̀Y Ţ / Resistance to Soldering Heat Test Conditions

| | | | |
|---|---|---|---|
| 270±5 | 10±1 sec. | Temp.:270±5 | Time:10±1 sec |

## ɒ Ŀ ᐸ— / Packaging SPEC.

/ TUBE

| Package Type | Units | | | | | Dimension | | (unit mm³) |
|---|---|---|---|---|---|---|---|---|
| | | | | | | | | |
| TO-220FL | 50 | 20 | 1,000 | 5 | 5,000 | 532×33×7.0 | 555×164×50 | 575×290×180 |

## ä ᵛ ŗ Ꞙ / Notices